

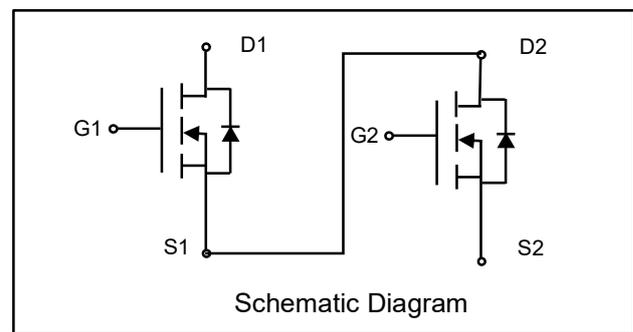
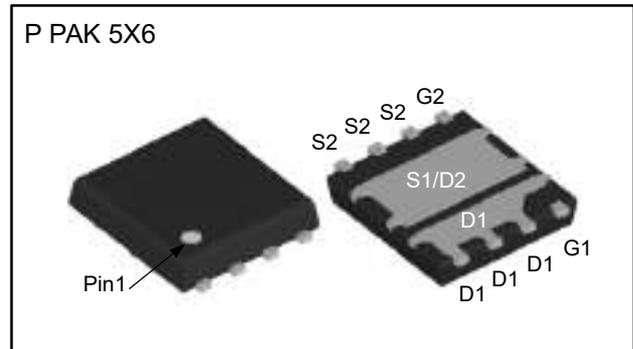
<b>BV<sub>DSS</sub></b>	<b>R<sub>DS(on)</sub></b>	<b>I<sub>D</sub></b>
30V	3.2mΩ	50A

### Features

- 1、 Low R<sub>DS(on)</sub> to Minimize conduction Losses.
- 2、 High power package (P PAK 5X6)
- 3、 Pb-Free Halogen Free and RoHS compliant
- 4、 Fast Switching Speed
- 5、 100% avalanche tested

### Applications

- 1、 On board power for server.
- 2、 On board power for server.
- 3、 DC/DC Converters.



### Packaging Specifications

Packing	Marking	Reel Size	Tape width	Basic ordering unit	Taping code
Embossed Tape		Ø330mm	12mm	5000	D5

### Absolute Maximum Ratings (T<sub>C</sub>=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-Source Voltage (V <sub>GS</sub> =0V)	30	V
V <sub>GS</sub>	Gate-Source Voltage (V <sub>GS</sub> =0V,static)	±20	V
I <sub>D</sub>	Continuous Drain Current (T <sub>C</sub> =25°C)	50	A
	Continuous Drain Current (T <sub>C</sub> =100°C)	31	A
I <sub>DM</sub> Note1	Pulesd Drain Current	140	A
I <sub>AS</sub>	Avalanche Current	38	A
E <sub>AS</sub> Note5	Single Pulsed Avalanche Energy	80	mJ
P <sub>D</sub>	Maximum Power Dissipation (T <sub>C</sub> =25°C)	34	W
	Maximum Power Dissipation (T <sub>C</sub> =100°C)	13	W
T <sub>J</sub> , T <sub>STG</sub>	Operating, Storage Temperature Range	-55~150	°C

### Thermal Characteristics

Symbol	Parameter	Max.	Unit
R <sub>θJA</sub> Note2	Thermal Resistance, Junction-to-Ambient	65	°C/W
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	3.7	°C/W